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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/578,869	05/11/2006	Honda Shoji	070759-0044	3265
20277 7590 05/22/2008 MCDERMOTT WILL & EMERY LLP			EXAMINER	
600 13TH STR	,		KING, JOSHUA	
WASHINGTON, DC 20005-3096			ART UNIT	PAPER NUMBER
			2828	
			MAIL DATE	DELIVERY MODE
			05/22/2008	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)				
Office Action Comments	10/578,869	SHOJI, HONDA				
Office Action Summary	Examiner	Art Unit				
	JOSHUA KING	2828				
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address				
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.  - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.  - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).						
Status						
1) Responsive to communication(s) filed on <u>07 Ma</u>	arch 2008					
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<i>i</i> —	<del>/ _</del>					
	closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
closed in accordance with the practice under Lx parte Quayle, 1935 C.D. 11, 405 C.C. 215.						
Disposition of Claims						
4)⊠ Claim(s) <u>1-7</u> is/are pending in the application.						
4a) Of the above claim(s) is/are withdrawn from consideration.						
5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>1-7</u> is/are rejected.						
7) Claim(s) is/are objected to.						
,	•					
Application Papers						
9)☐ The specification is objected to by the Examiner.						
10)⊠ The drawing(s) filed on <u>11 May 2006</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).						
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.						
Priority under 35 U.S.C. § 119						
12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).						
a)⊠ All b)⊡ Some * c)⊡ None of:						
<ol> <li>Certified copies of the priority documents</li> </ol>	1. Certified copies of the priority documents have been received.					
<ol><li>Certified copies of the priority documents</li></ol>	2. Certified copies of the priority documents have been received in Application No					
<ol><li>Copies of the certified copies of the prior</li></ol>	3. Copies of the certified copies of the priority documents have been received in this National Stage					
application from the International Bureau	application from the International Bureau (PCT Rule 17.2(a)).					
* See the attached detailed Office action for a list of the certified copies not received.						
Attachment(s)						
1) Notice of References Cited (PTO-892)  4) Interview Summary (PTO-413)						
2) Notice of Draftsperson's Patent Drawing Review (PTO-948) Paper No(s)/Mail Date.						
3) Information Disclosure Statement(s) (PTO/SB/08)  Space No(s)/Mail Date  6) Other						
Paper No(s)/Mail Date 6)						

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#### **DETAILED ACTION**

#### Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 02/01/2008 has been entered.

### Response to Arguments

- 2. Applicant's arguments filed 02/01/2008 have been fully considered but they are not persuasive. In short, the applicant's amendment has not overcome the previous rejection because Hosokawa et al. (U.S. Pre-Grant Publication 2004/0105472) still shows "a lower end portion of the element mount surface and a bottom surface of the depression face each other with a space left there between". The examiner has provided a mark-up of Fig. 3 which shows how this limitation is met by the figure below.
- 3. The examiner recommends applicant considers amending claim 1, to further include a recitation defining how the bottom surface of the heat sink contacts the base portion. As shown in Figs. 3 and 4 of Hosokawa et al., the base portion and heat sink are in full contact over the entire width of the heat sink element. However, as disclosed in Figures 1, 3, and 4 of the instant application the bottom width of the heat sink is shown to overlap the depression. Such a recitation might read as "the heat sink portion is positioned such that the bottom surface of the heat sink portion is not completely

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contacted by the base portion, such that the bottom of the element mount surface does not contact the base portion". The examiner believes that such a recitation would overcome the rejection cited in this office action. Please note, that the examiner **IS NOT** indicating any material as allowable, only that such a recitation would overcome the current rejection.

4. Applicants have also amended claim 6 to recite "that can prevent feedback light from being produced by diffusely reflecting secondary laser light". As was noted in the previous rejection, all surfaces have an innate roughness which diffuses light. When the diffusion of light prevents the majority of light from returning on its original path. As such feedback is prevented. The applicant is advised that the easiest way to overcome this rejection based on inherency is to claim a value of how rough the surface is. The applicants should ensure that such a recitation is supported by the specification. It should also be noted that "that can" statements do not generally limit the claim. Applicant is claiming a device and trying to claim a structural feature (surface roughness) by its function. The function only limits the claim in the structure it implies (i.e. function does not differentiate a device claim from the prior art). In this case, the functional language recites no additional limitations. In fact, "that can" implies "is able to but not necessarily does", which weakens the claim even further.

## **Priority**

5. Receipt is acknowledged of papers submitted under 35 U.S.C. 119(a)-(d), which papers have been placed of record in the file.

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## Claim Objections

6. Claim 1 is objected to because of the following informalities: "therebetween" should be written as "there between". Appropriate correction is required.

# Claim Rejections - 35 USC § 102

7. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- 8. Claims 1-7 are rejected under 35 U.S.C. 102(e) as being anticipated by Hosokawa et al. (U.S. Pre-Grant Publication 2004/0105472).
- 9. With respect to claim 1, Hosokawa et al. discloses a base portion having a horizontal top surface (Fig. 3 element 1); a heat sink portion that has a vertical element mount surface and is located above the top surface of the base portion (Fig. 3 element 17); a semiconductor laser element that is fixed to the element mount surface (Fig. 3 element 3); and a depression that is formed in the top surface of the base portion located immediately below the semiconductor laser element so as to receive part of the semiconductor laser element disposed therein (Fig. 3 element 5), wherein the heat sink portion is fixed to the base portion in such a way that the element mount surface is located inward of an inner side surface of the depression (Fig. 3 elements 5 and 17), and that a lower end portion of the element mount surface (Fig. 3 element 17) and a

bottom surface of the depression face each other with a space left there between (Fig. 3 element 5).

bottom surface of the depression

h2 5 17 20

lower end portion element mount surface

10.

- 11. **With respect to claim 2**, Hosokawa et al. further discloses the depression is formed within an area of a circle including, on a circumference thereof, a plurality of lead pins that feed a voltage to the semiconductor laser element ([0017]).
- 12. **With respect to claim 3**, Hosokawa et al. further discloses the semiconductor laser element is fixed to the heat sink portion via a submount, part of which is disposed in the depression (Fig. 3 element 2).
- 13. With respect to claim 4, Hosokawa et al. further discloses a length of the semiconductor laser element is longer than a height of the heat sink portion (Fig. 1 elements h1 and L). It should be noted that the applicant has admitted in the disclosure

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that the lengths of the elements is a matter of design choice (see [0054] of 2007/0086494 which is the Pre-Grant Publication of the instant application).

- 14. **With respect to claim 5**, Hosokawa et al. further discloses the base portion and the heat sink portion are formed as a single member (Fig. 1 elements 1 and 7). It should be stated that the courts have found that making two elements integral only requires ordinary skill in the art.
- 15. With respect to claim 6, Hosokawa et al. further discloses the depression has a rough bottom surface that can prevent feedback light from being produced by diffusely reflecting secondary laser light. While not explicitly stated all surfaces have some roughness which diffusely reflects secondary laser light, so the recitation is anticipated through inherency.
- 16. **With respect to claim 7**, Hosokawa et al. further discloses the depression has an inclined bottom surface (Fig. 3 element 5).

#### Conclusion

17. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Hamasaki et al. (U.S. Patent Number 6,449,296) discloses the effects of a roughened surface in the recessed portion. Simoun-Ou et al. (U.S. Pre-Grant Publication 2005/0105572) discloses a laser device with a recessed base. Tanaka et al. (U.S. Patent Number 5,089,861) discloses a recessed portion base. Shimonaka (U.S. Pre-Grant Publication 2002/0154667) discloses the effects of a roughened surface to laser light. Ichikawa et al. (U.S. Pre-Grant Publications

2001/0026991 and 2003/0165167) which disclose a recessed base of a semiconductor device.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to JOSHUA KING whose telephone number is (571)270-1441. The examiner can normally be reached on Mon.-Thurs. 10:00-7:30 and other Fri. 10:00-6:30.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Min Sun Harvey can be reached on 571-272-1835. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/Joshua King/ Examiner, Art Unit 2828

/Minsun Harvey/ Supervisory Patent Examiner, Art Unit 2828